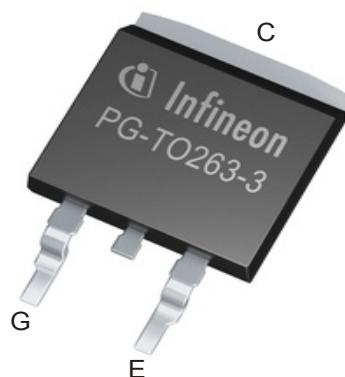
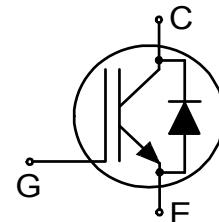


High speed switching series 5<sup>th</sup> generation

TRENCHSTOP™ 5 high speed switching IGBT copacked with full rated current RAPID 1 anti parallel diode

#### Features and Benefits:

- High speed H5 technology offering
- Best-in-Class efficiency in hard switching and resonant topologies
- 650V breakdown voltage
- Low  $Q_G$
- IGBT copacked with full rated current RAPID 1 fast antiparallel diode
- Maximum junction temperature 175°C
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models:  
<http://www.infineon.com/igbt/>



#### Potential Applications:

- Energy Generation
  - Solar String Inverter
  - Solar Micro Inverter
- Industrial Power Supplies
  - Industrial SMPS
  - Industrial UPS
- Metal Treatment
  - Welding
- Energy Distribution
  - Energy Storage
- Infrastructure – Charge
  - Charger

#### Product Validation:

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



#### Key Performance and Package Parameters

Type	$V_{CE}$	$I_C$	$V_{CEsat}, T_{vj}=25^\circ C$	$T_{vjmax}$	Marking	Package
IKB20N65EH5	650V	20A	1.65V	175°C	K20EEH5	PG-T0263-3

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High speed switching series 5<sup>th</sup> generation**Table of Contents**

Description .....	1
Table of Contents .....	2
Maximum Ratings .....	3
Thermal Resistance .....	3
Electrical Characteristics .....	4
Electrical Characteristics Diagrams .....	7
Package Drawing .....	13
Testing Conditions .....	14
Revision History .....	15
Disclaimer .....	16

## High speed switching series 5<sup>th</sup> generation

### Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25^\circ\text{C}$	$V_{CE}$	650	V
DC collector current, limited by $T_{vjmax}$ $T_c = 25^\circ\text{C}$ $T_c = 100^\circ\text{C}$	$I_C$	38.0 25.0	A
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$	60.0	A
Turn off safe operating area $V_{CE} \leq 650\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$ , $t_p = 1\mu\text{s}$	-	60.0	A
Diode forward current, limited by $T_{vjmax}$ $T_c = 25^\circ\text{C}$ value limited by bondwire $T_c = 100^\circ\text{C}$	$I_F$	40.0 27.0	A
Diode pulsed current, $t_p$ limited by $T_{vjmax}$	$I_{Fpuls}$	60.0	A
Gate-emitter voltage Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )	$V_{GE}$	$\pm 20$ $\pm 30$	V
Power dissipation $T_c = 25^\circ\text{C}$ Power dissipation $T_c = 100^\circ\text{C}$	$P_{tot}$	125.0 62.5	W
Operating junction temperature	$T_{vj}$	-40...+175	°C
Storage temperature	$T_{stg}$	-55...+150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STA-020)		260	°C

### Thermal Resistance

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>R<sub>th</sub> Characteristics</b>						
IGBT thermal resistance, junction - case	$R_{th(j-c)}$		-	-	1.20	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		-	-	1.50	K/W
Thermal resistance, min. footprint junction - ambient	$R_{th(j-a)}$		-	-	65	K/W
Thermal resistance, 6cm <sup>2</sup> Cu on PCB junction - ambient	$R_{th(j-a)}$		-	-	40	K/W

High speed switching series 5<sup>th</sup> generationElectrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(\text{BR})\text{CES}}$	$V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 0.20\text{mA}$	650	-	-	V
Collector-emitter saturation voltage	$V_{\text{CEsat}}$	$V_{\text{GE}} = 15.0\text{V}, I_{\text{C}} = 20.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.65	2.10	V
Diode forward voltage	$V_F$	$V_{\text{GE}} = 0\text{V}, I_F = 20.0\text{A}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 125^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	1.45	1.70	V
Gate-emitter threshold voltage	$V_{\text{GE}(\text{th})}$	$I_{\text{C}} = 0.20\text{mA}, V_{\text{CE}} = V_{\text{GE}}$	3.2	4.0	4.8	V
Zero gate voltage collector current	$I_{\text{CES}}$	$V_{\text{CE}} = 650\text{V}, V_{\text{GE}} = 0\text{V}$ $T_{vj} = 25^\circ\text{C}$ $T_{vj} = 175^\circ\text{C}$	-	-	50	$\mu\text{A}$
Gate-emitter leakage current	$I_{\text{GES}}$	$V_{\text{CE}} = 0\text{V}, V_{\text{GE}} = 20\text{V}$	-	-	100	nA
Transconductance	$g_{\text{fs}}$	$V_{\text{CE}} = 20\text{V}, I_{\text{C}} = 20.0\text{A}$	-	24.0	-	S

Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{\text{ies}}$		-	1200	-	
Output capacitance	$C_{\text{oes}}$	$V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$	-	30	-	pF
Reverse transfer capacitance	$C_{\text{res}}$		-	5	-	
Gate charge	$Q_G$	$V_{\text{CC}} = 520\text{V}, I_{\text{C}} = 20.0\text{A}, V_{\text{GE}} = 15\text{V}$	-	48.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	7.0	-	nH

## Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic, at <math>T_{vj} = 25^\circ\text{C}</math></b>						
Turn-on delay time	$t_{d(\text{on})}$	$T_{vj} = 25^\circ\text{C}, V_{\text{CC}} = 400\text{V}, I_{\text{C}} = 20.0\text{A}, V_{\text{GE}} = 0.0/15.0\text{V}, R_{G(\text{on})} = 32.0\Omega, R_{G(\text{off})} = 32.0\Omega, L_{\sigma} = 30\text{nH}, C_{\sigma} = 30\text{pF}$	-	19	-	ns
Rise time	$t_r$		-	21	-	ns
Turn-off delay time	$t_{d(\text{off})}$		-	160	-	ns
Fall time	$t_f$		-	23	-	ns
Turn-on energy	$E_{\text{on}}$		-	0.56	-	mJ
Turn-off energy	$E_{\text{off}}$		-	0.13	-	mJ
Total switching energy	$E_{\text{ts}}$	Energy losses include "tail" and diode reverse recovery.	-	0.69	-	mJ

High speed switching series 5<sup>th</sup> generation

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 25^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 10.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 32.0\Omega$ , $R_{G(off)} = 32.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	17	-	ns
Rise time	$t_r$		-	11	-	ns
Turn-off delay time	$t_{d(off)}$		-	160	-	ns
Fall time	$t_f$		-	27	-	ns
Turn-on energy	$E_{on}$		-	0.23	-	mJ
Turn-off energy	$E_{off}$		-	0.05	-	mJ
Total switching energy	$E_{ts}$		-	0.28	-	mJ

Diode Characteristic, at  $T_{vj} = 25^\circ\text{C}$ 

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 20.0\text{A}$ , $di_F/dt = 800\text{A}/\mu\text{s}$	-	80	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.50	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	8.5	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-750	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 25^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 10.0\text{A}$ , $di_F/dt = 860\text{A}/\mu\text{s}$	-	56	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.36	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	10.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-500	-	$\text{A}/\mu\text{s}$

## Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

IGBT Characteristic, at  $T_{vj} = 150^\circ\text{C}$ 

Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 20.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 32.0\Omega$ , $R_{G(off)} = 32.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	19	-	ns
Rise time	$t_r$		-	22	-	ns
Turn-off delay time	$t_{d(off)}$		-	180	-	ns
Fall time	$t_f$		-	19	-	ns
Turn-on energy	$E_{on}$		-	0.70	-	mJ
Turn-off energy	$E_{off}$		-	0.15	-	mJ
Total switching energy	$E_{ts}$		-	0.85	-	mJ
Turn-on delay time	$t_{d(on)}$	$T_{vj} = 150^\circ\text{C}$ , $V_{CC} = 400\text{V}$ , $I_C = 10.0\text{A}$ , $V_{GE} = 0.0/15.0\text{V}$ , $R_{G(on)} = 32.0\Omega$ , $R_{G(off)} = 32.0\Omega$ , $L_\sigma = 30\text{nH}$ , $C_\sigma = 30\text{pF}$ $L_\sigma$ , $C_\sigma$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	17	-	ns
Rise time	$t_r$		-	12	-	ns
Turn-off delay time	$t_{d(off)}$		-	180	-	ns
Fall time	$t_f$		-	23	-	ns
Turn-on energy	$E_{on}$		-	0.34	-	mJ
Turn-off energy	$E_{off}$		-	0.06	-	mJ
Total switching energy	$E_{ts}$		-	0.40	-	mJ

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 High speed switching series 5<sup>th</sup> generation

**Diode Characteristic, at  $T_{vj} = 150^\circ\text{C}$** 

Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 20.0\text{A}$ , $di_F/dt = 800\text{A}/\mu\text{s}$	-	108	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	1.08	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	13.5	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-620	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	$t_{rr}$	$T_{vj} = 150^\circ\text{C}$ , $V_R = 400\text{V}$ , $I_F = 10.0\text{A}$ , $di_F/dt = 750\text{A}/\mu\text{s}$	-	80	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.77	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	13.0	-	A
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	-650	-	$\text{A}/\mu\text{s}$

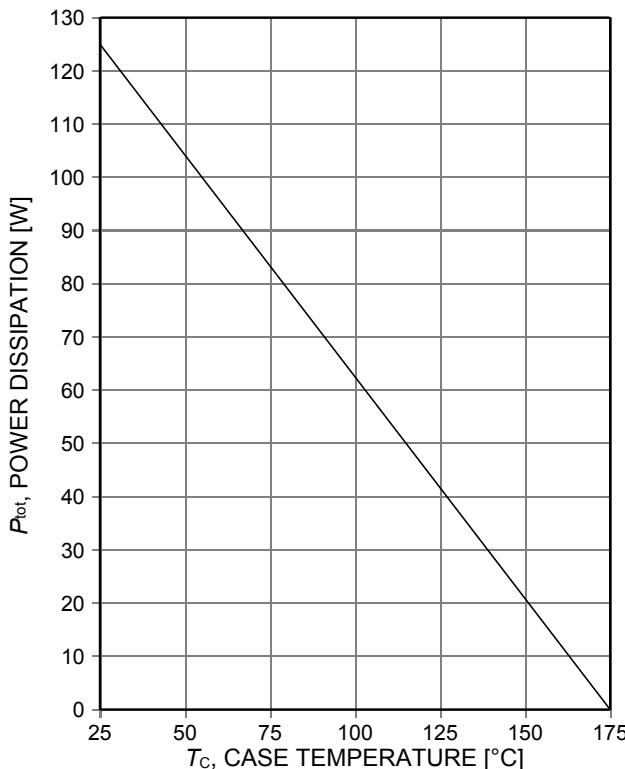
High speed switching series 5<sup>th</sup> generation

Figure 1. Power dissipation as a function of case temperature  
( $T_{vj} \leq 175^\circ\text{C}$ )

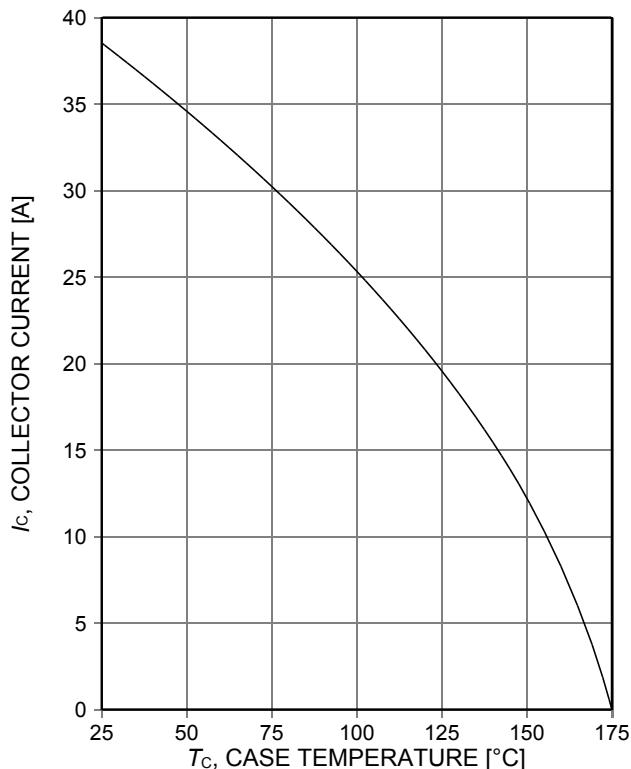


Figure 2. Collector current as a function of case temperature  
( $V_{GE} \geq 15\text{V}$ ,  $T_{vj} \leq 175^\circ\text{C}$ )

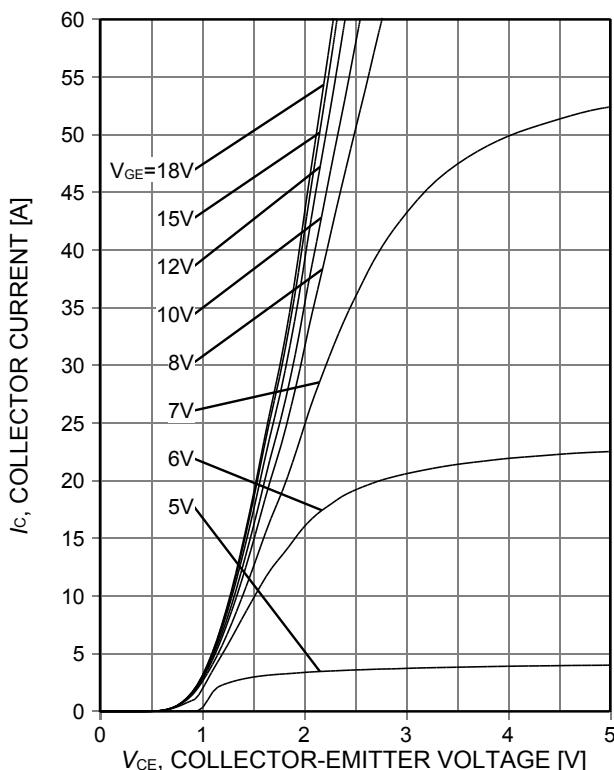


Figure 3. Typical output characteristic  
( $T_{vj} = 25^\circ\text{C}$ )

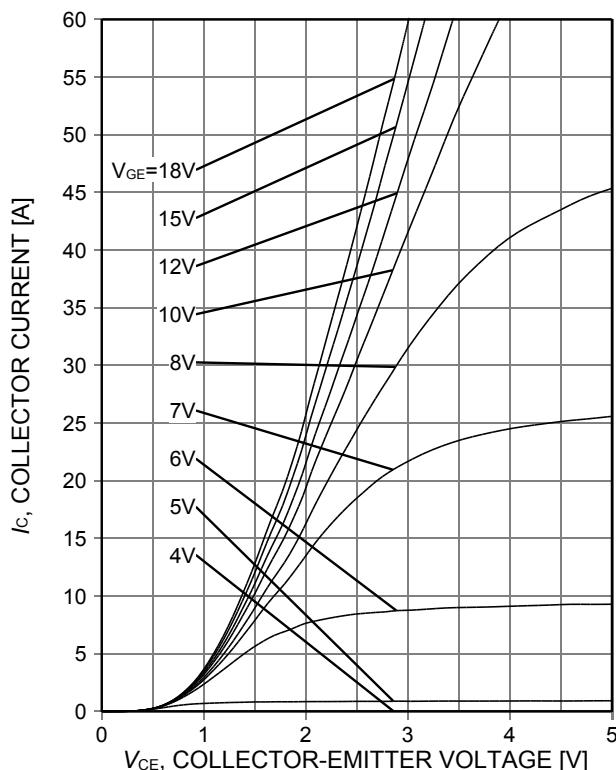


Figure 4. Typical output characteristic  
( $T_{vj} = 150^\circ\text{C}$ )

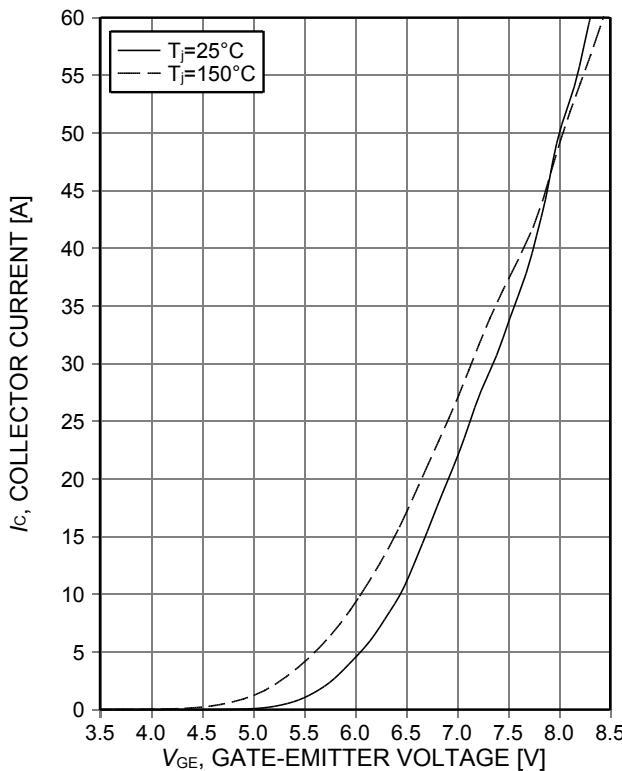
High speed switching series 5<sup>th</sup> generation

Figure 5. Typical transfer characteristic  
( $V_{CE}=20\text{V}$ )

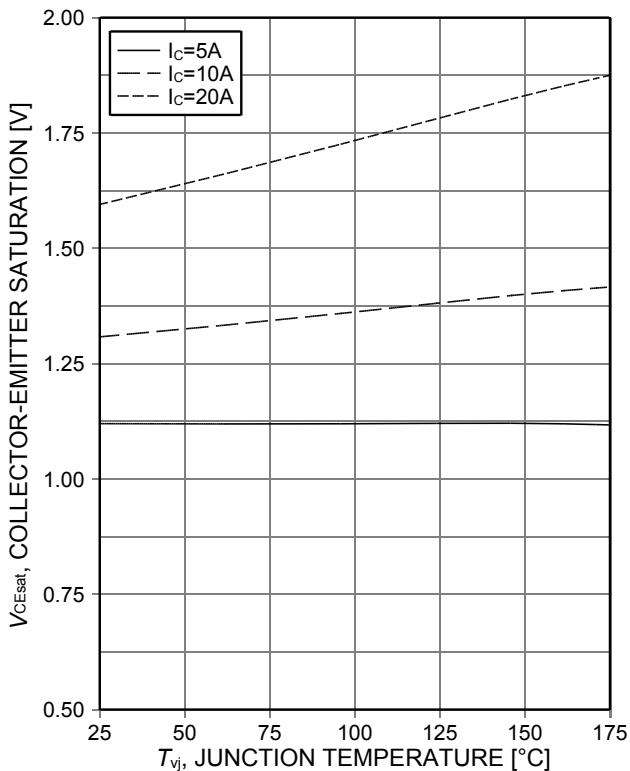


Figure 6. Typical collector-emitter saturation voltage as a function of junction temperature  
( $V_{GE}=15\text{V}$ )

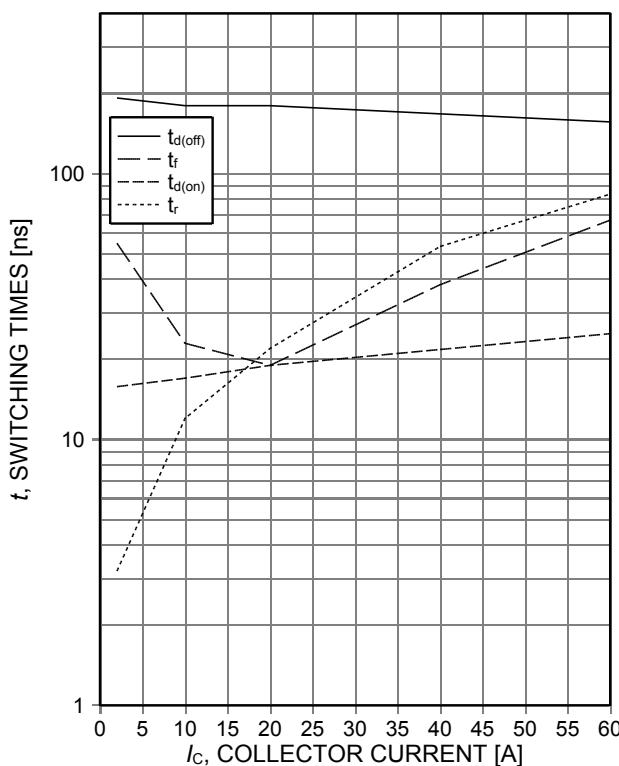


Figure 7. Typical switching times as a function of collector current  
(inductive load,  $T_j=150^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  
 $V_{GE}=0/15\text{V}$ ,  $R_G=32\Omega$ , Dynamic test circuit in  
Figure E)

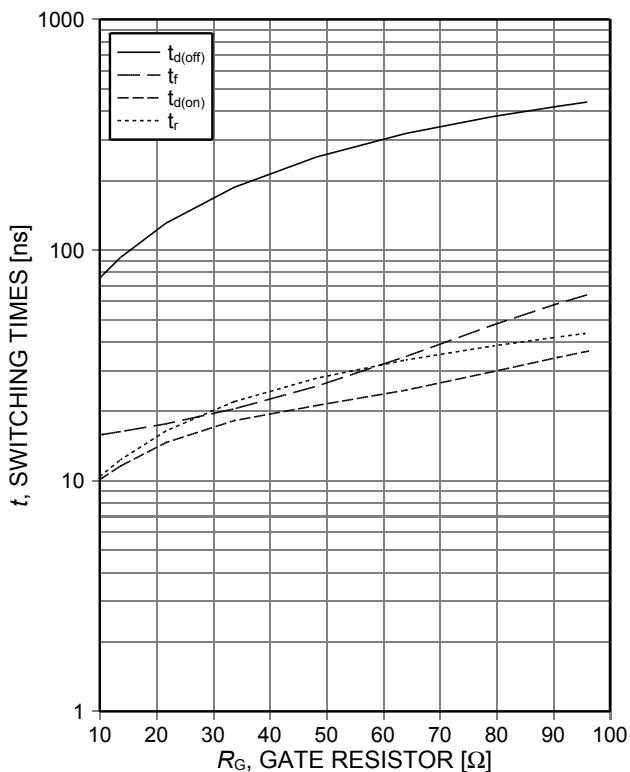
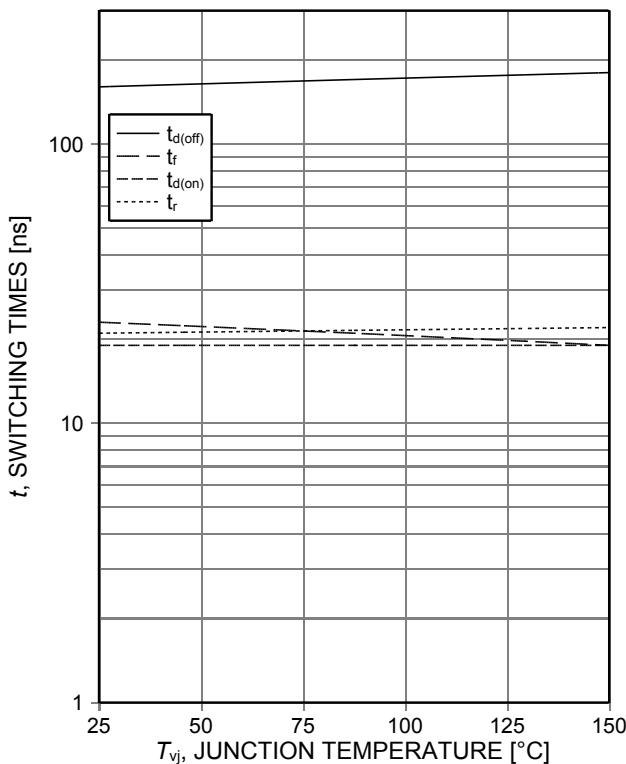
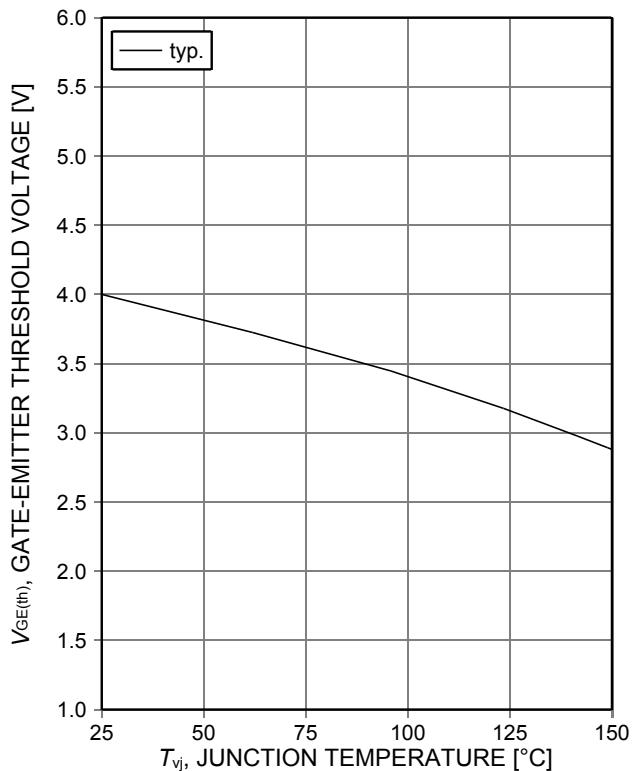


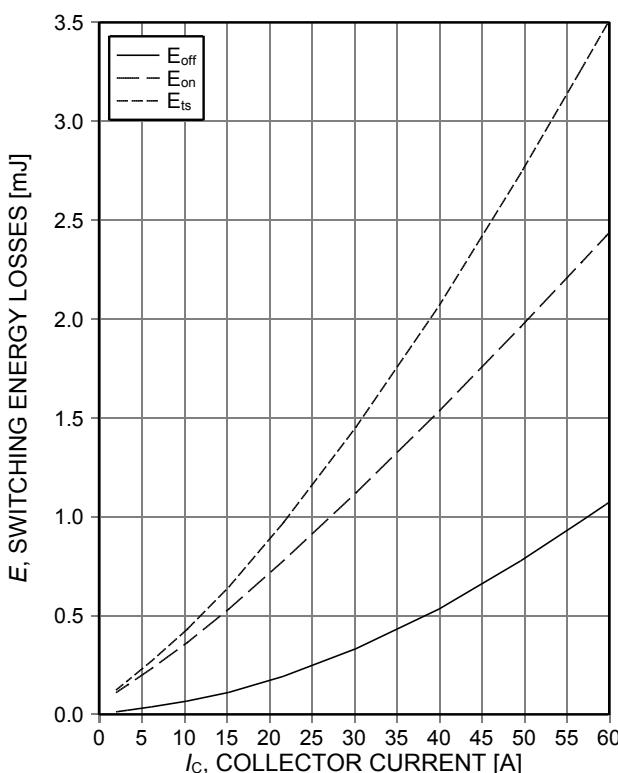
Figure 8. Typical switching times as a function of gate resistor  
(inductive load,  $T_j=150^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  
 $V_{GE}=0/15\text{V}$ ,  $I_c=20\text{A}$ , Dynamic test circuit in  
Figure E)

High speed switching series 5<sup>th</sup> generation

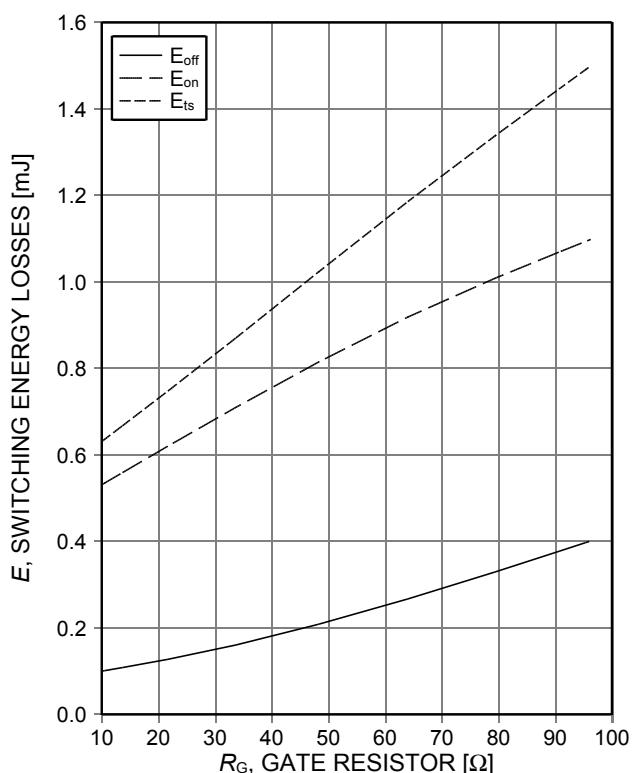
**Figure 9. Typical switching times as a function of junction temperature**  
 (inductive load,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=20A$ ,  $R_G=32\Omega$ , Dynamic test circuit in Figure E)



**Figure 10. Gate-emitter threshold voltage as a function of junction temperature**  
 ( $I_C=0.2mA$ )



**Figure 11. Typical switching energy losses as a function of collector current**  
 (inductive load,  $T_{vj}=150^{\circ}\text{C}$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $R_G=32\Omega$ , Dynamic test circuit in Figure E)



**Figure 12. Typical switching energy losses as a function of gate resistor**  
 (inductive load,  $T_{vj}=150^{\circ}\text{C}$ ,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=20A$ , Dynamic test circuit in Figure E)

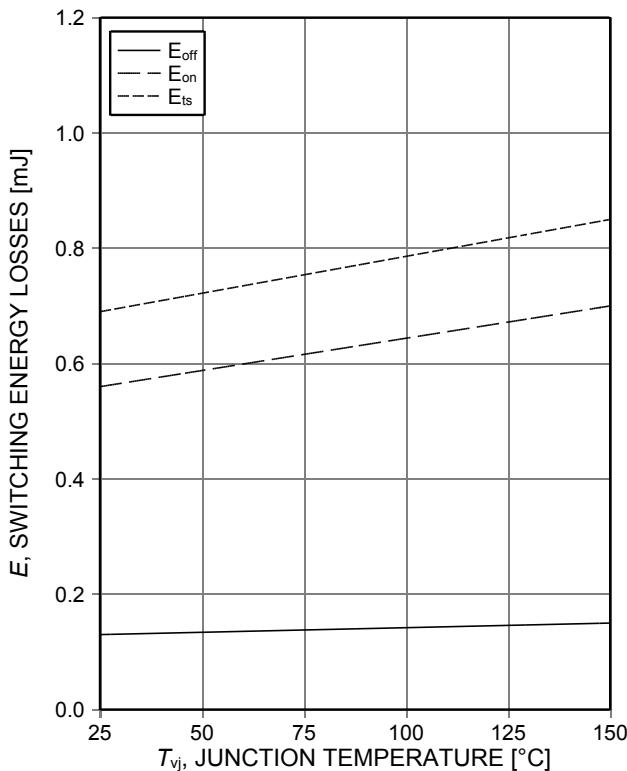
High speed switching series 5<sup>th</sup> generation

Figure 13. **Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE}=400V$ ,  $V_{GE}=0/15V$ ,  $I_C=20A$ ,  $R_G=32\Omega$ , Dynamic test circuit in Figure E)

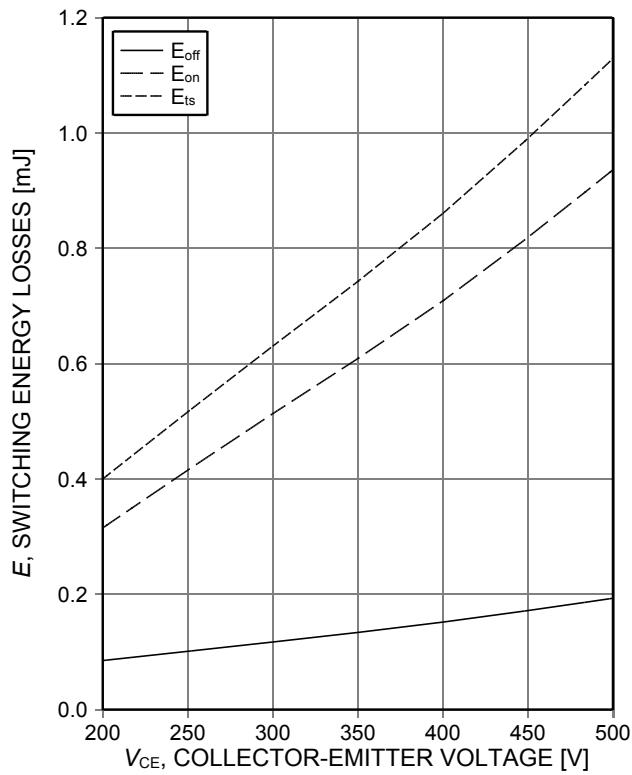


Figure 14. **Typical switching energy losses as a function of collector-emitter voltage**  
(inductive load,  $T_{vj}=150^{\circ}C$ ,  $V_{GE}=0/15V$ ,  $I_C=20A$ ,  $R_G=32\Omega$ , Dynamic test circuit in Figure E)

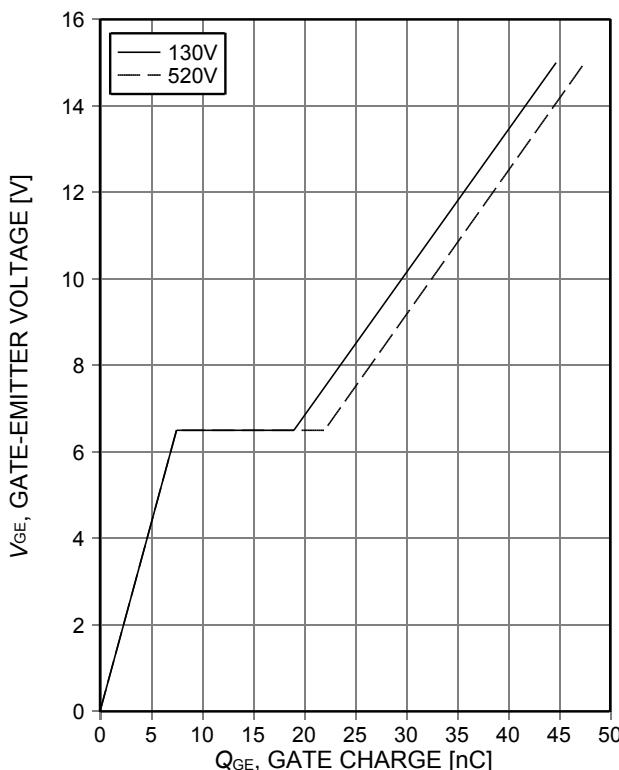


Figure 15. **Typical gate charge**  
( $I_C=20A$ )

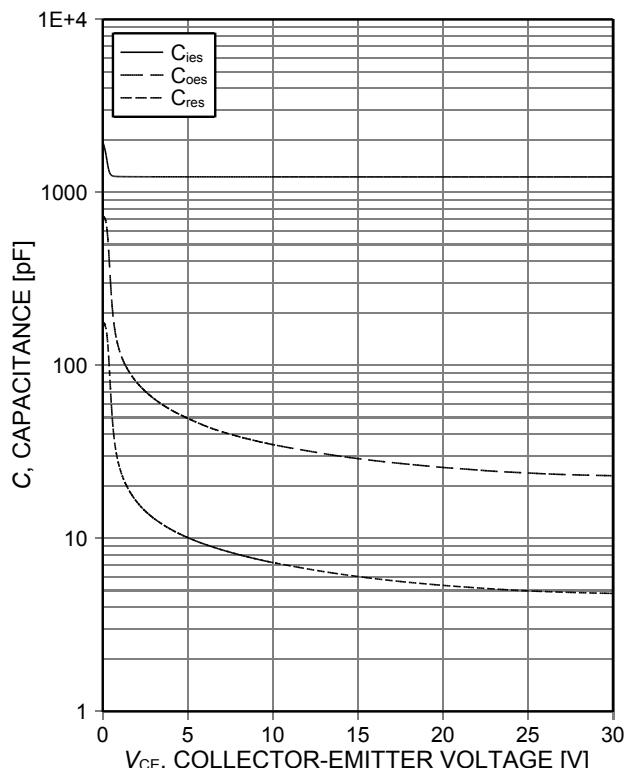
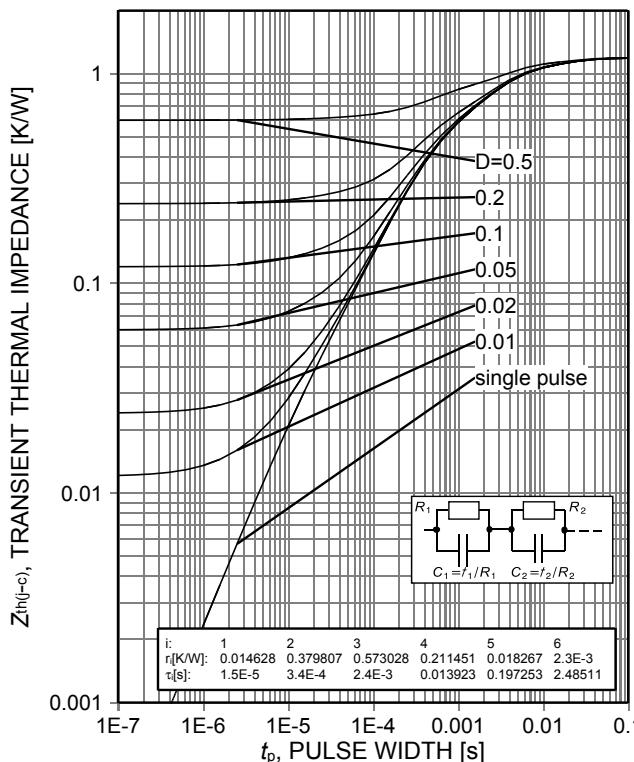
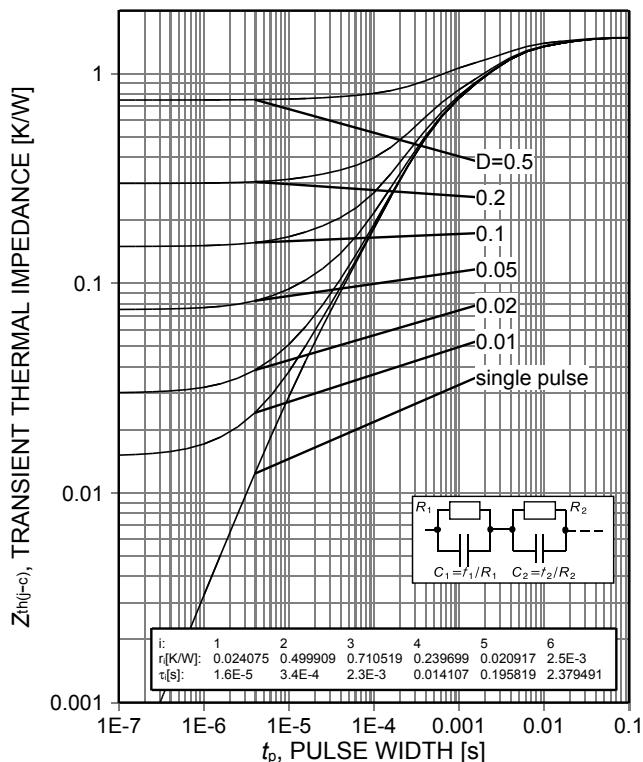
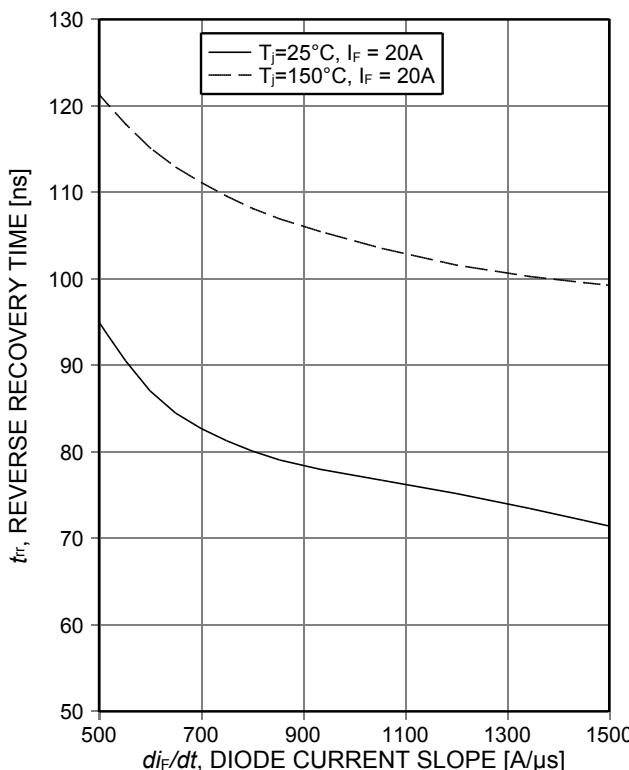
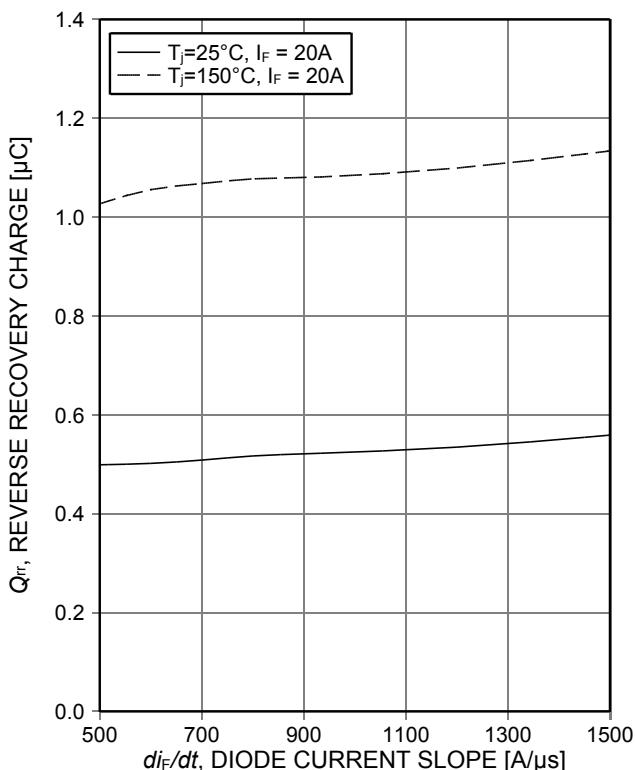


Figure 16. **Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0V$ ,  $f=1MHz$ )

High speed switching series 5<sup>th</sup> generationFigure 17. IGBT transient thermal impedance ( $D=t_p/T$ )Figure 18. Diode transient thermal impedance as a function of pulse width ( $D=t_p/T$ )Figure 19. Typical reverse recovery time as a function of diode current slope ( $V_R=400\text{V}$ )Figure 20. Typical reverse recovery charge as a function of diode current slope ( $V_R=400\text{V}$ )

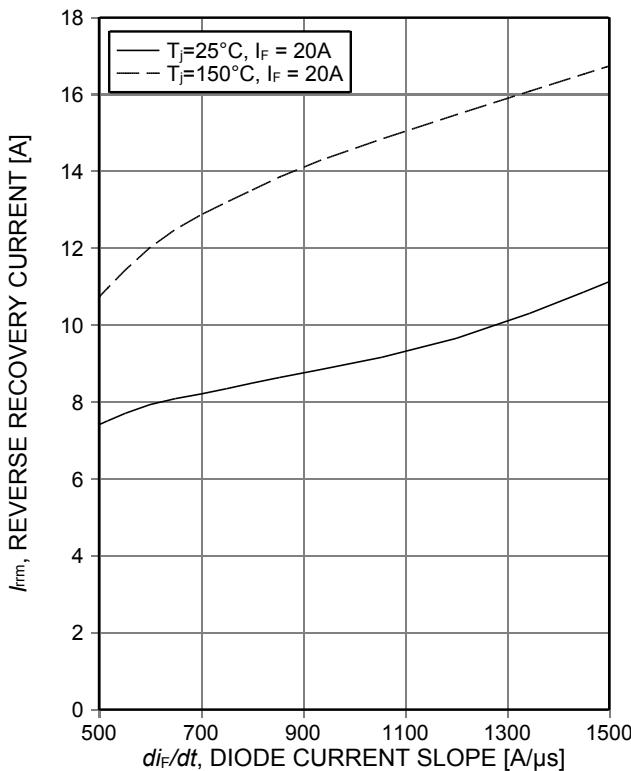
High speed switching series 5<sup>th</sup> generation

Figure 21. Typical peak reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

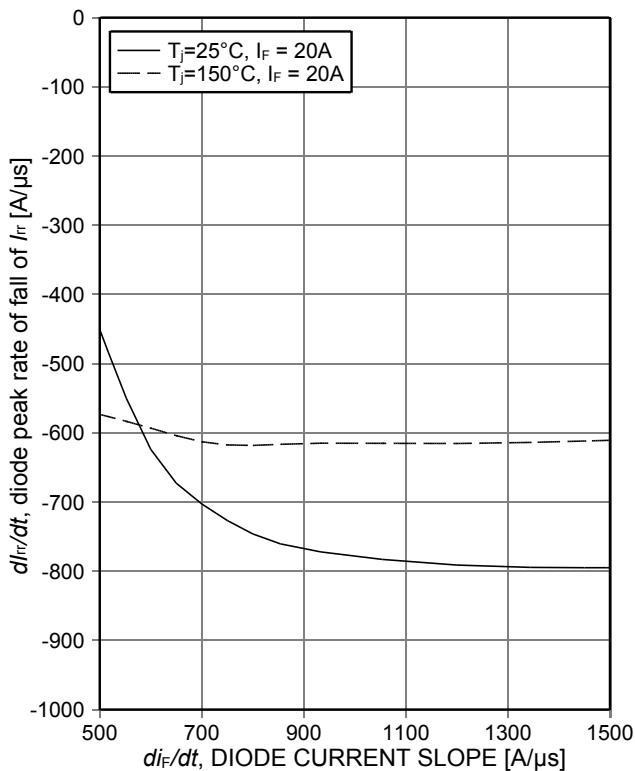


Figure 22. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R=400\text{V}$ )

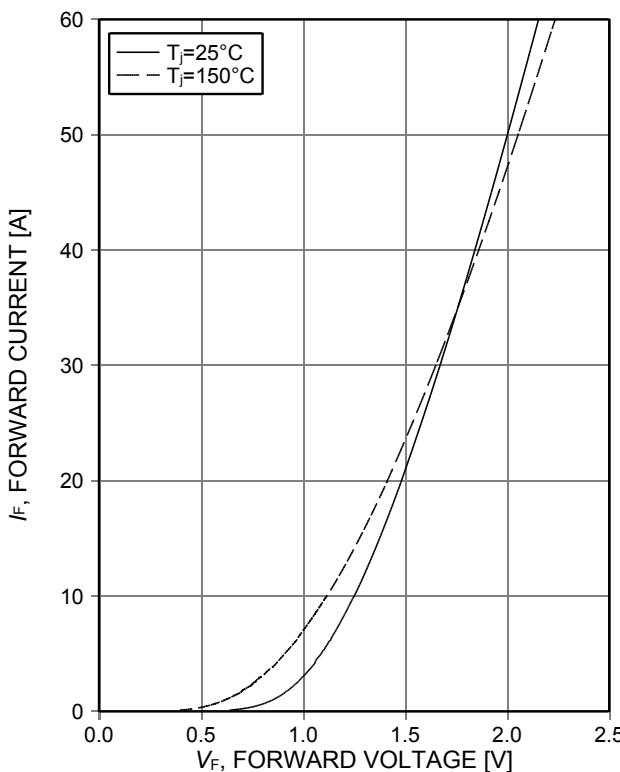


Figure 23. Typical diode forward current as a function of forward voltage

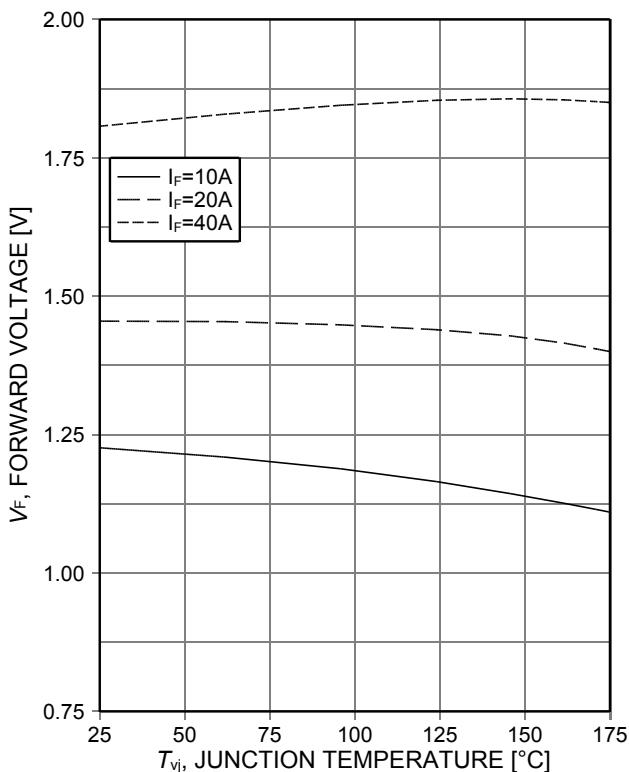
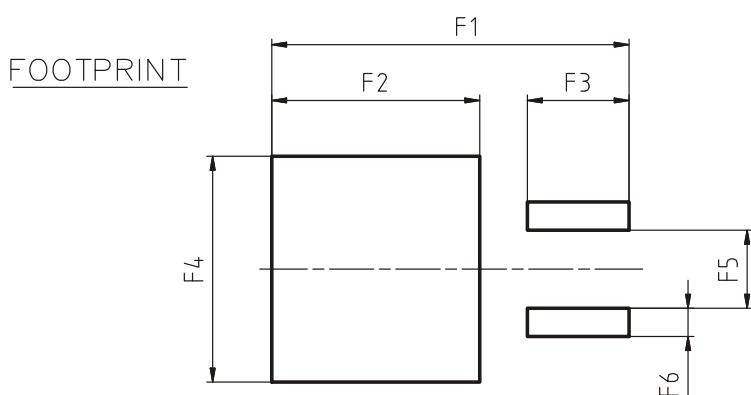
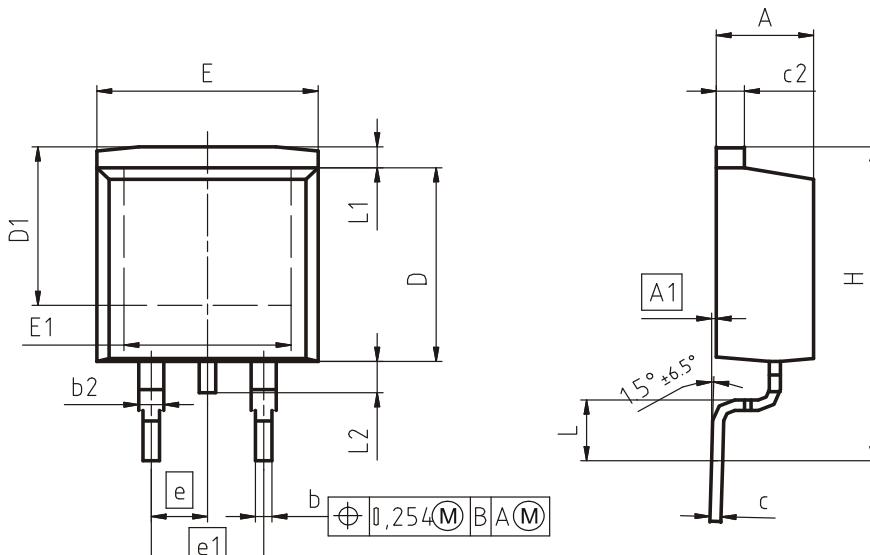


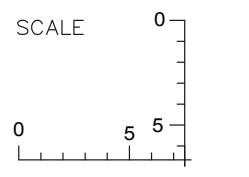
Figure 24. Typical diode forward voltage as a function of junction temperature

High speed switching series 5<sup>th</sup> generation

## Package Drawing PG-TO263-3



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	0.00	0.25	0.000	0.010
b	0.65	0.85	0.026	0.033
b2	0.95	1.15	0.037	0.045
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.51	9.45	0.335	0.372
D1	7.10	7.90	0.280	0.311
E	9.80	10.31	0.386	0.406
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	2		2	
H	14.61	15.88	0.575	0.625
L	2.29	3.00	0.090	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
F1	16.05	16.25	0.632	0.640
F2	9.30	9.50	0.366	0.374
F3	4.50	4.70	0.177	0.185
F4	10.70	10.90	0.421	0.429
F5	3.65	3.85	0.144	0.152
F6	1.25	1.45	0.049	0.057

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High speed switching series 5<sup>th</sup> generation

## Testing Conditions

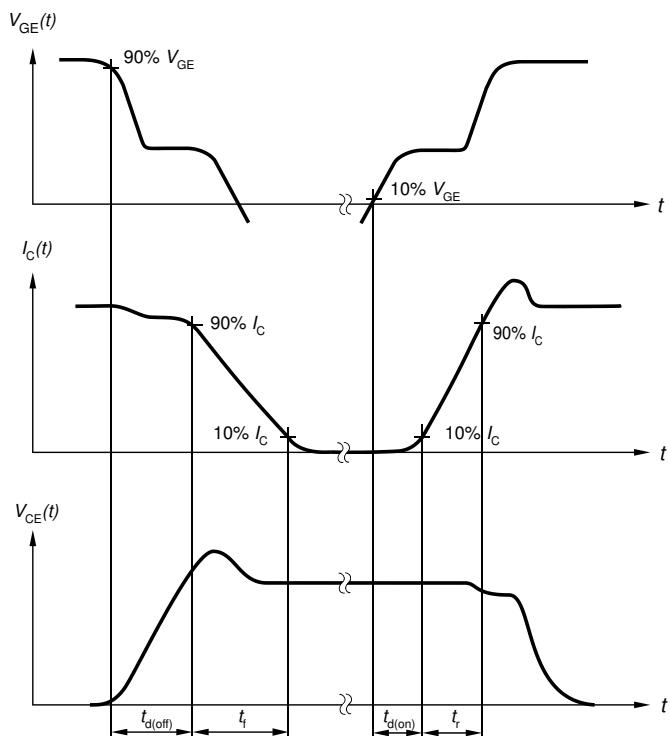


Figure A. Definition of switching times

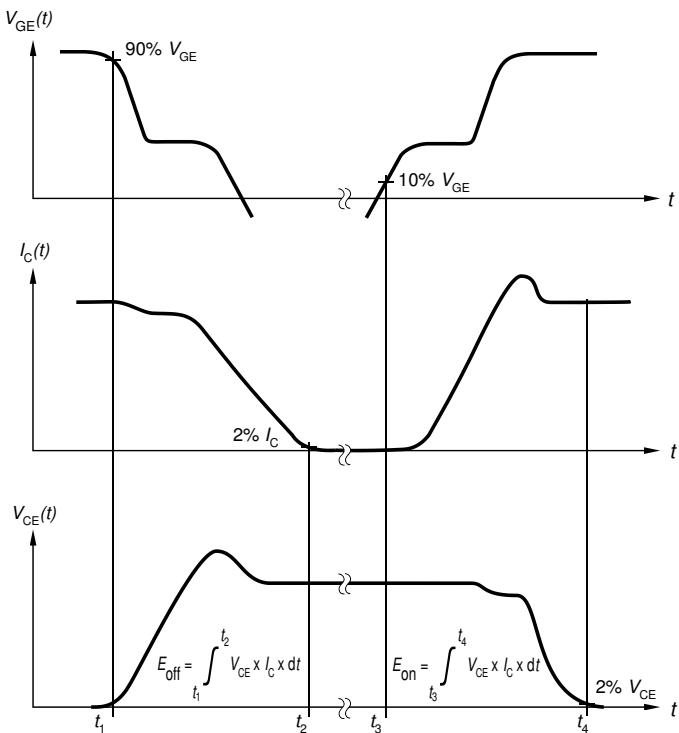


Figure B. Definition of switching losses

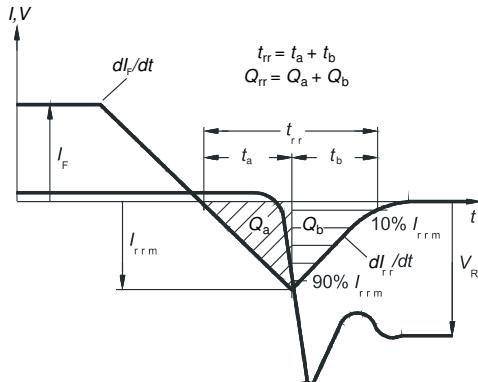


Figure C. Definition of diode switching characteristics

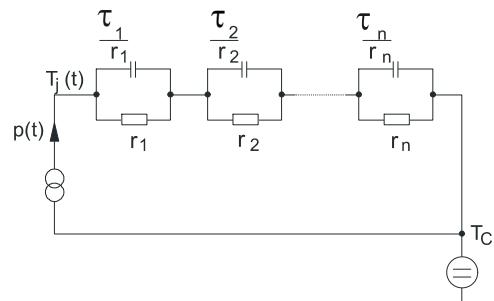


Figure D. Thermal equivalent circuit

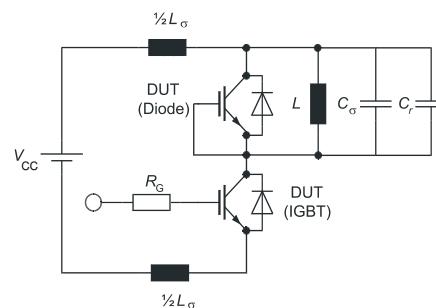


Figure E. Dynamic test circuit  
 Parasitic inductance  $L_\sigma$ ,  
 parasitic capacitor  $C_\sigma$ ,  
 relief capacitor  $C_r$ ,  
 (only for ZVT switching)

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High speed switching series 5<sup>th</sup> generation**Revision History**

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IKB20N65EH5

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**Revision: 2018-01-11, Rev. 2.1**

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Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2018-01-11	Final data sheet

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